



SMD Comm X8G HT150C Flex, Ceramic, 300 pF, 5%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

300 pF

Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm
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W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm
Packaging Specifications	

L	1.6mm +/-0.17mm	Measurement Condition	1 MHz 1.0Vrms
W	0.8mm +/-0.15mm	Tolerance	5%
T	0.8mm +/-0.15mm	Voltage DC	250 VDC
S	0.4mm MIN	Dielectric Withstanding Voltage	625 VDC
В	0.45mm +/-0.15mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
Packaging Specifications		Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
Packaging	T&R, 330mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity 15000		Dissipation Factor	0.1% 1 MHz 1.0Vrms
		Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
		Inculation Posistance	100 COhms

Specifications

Capacitance

Packaging Quantity		15000	Applied (TCC)		
	15000		Dissipation Factor	0.1% 1 MHz 1.0Vrms	
			Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
			Insulation Resistance	100 GOhms	

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